

RAF040P01TCR-VB Datasheet

P-Channel 20 V (D-S) MOSFET

PRODUCT SUMMARY						
V _{DS} (V)	$R_{DS(on)}(\Omega)$	I _D (A) ^c	Q _g (Typ.)			
- 20	0.080 at V _{GS} = - 4.5 V	- 3.1	4.3 nC			
- 20	0.100 at V _{GS} = - 2.5 V	- 2.3	4.5110			

FEATURES

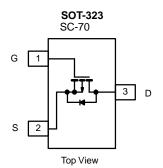
- Halogen-free According to IEC 61249-2-21 Definition
- Trench Power MOSFET
- 100 % R_g Tested
- Compliant to RoHS Directive 2002/95/EC

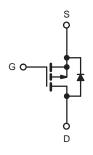


HALOGEN FREE

APPLICATIONS

- Load Switch
- DC/DC Converters





P-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS (T_A = 25 °C, unless otherwise noted) **Parameter** Symbol Limit Unit - 20 Drain-Source Voltage V_{DS} ٧ V_{GS} Gate-Source Voltage ± 12 $T_C = 25 \, ^{\circ}C$ - 3.1 T_C = 70 °C - 2.1 Continuous Drain Current (T_J = 150 °C) I_D T_A = 25 °C - 1.4^{a, b} $T_A = 70 \, ^{\circ}C$ - 1.1^{a, b} Α I_{DM} **Pulsed Drain Current** - 6 T_C = 25 °C - 0.4 Continuous Source-Drain Diode Current I_S T_A = 25 °C - 0.3 T_C = 25 °C 0.5 T_C = 70 °C 0.3 P_D Maximum Power Dissipation W T_A = 25 °C 0.4^{a, b} T_A = 70 °C 0.3^{a, b} T_J , T_{stg} - 50 to 150 Operating Junction and Storage Temperature Range °С 260 Soldering Recommendations (Peak Temperature)

a. Surface mounted on 1" x 1" FR4 board.

b. t = 10 s.

c. Based on $T_C = 25$ °C.



THERMAL RESISTANCE RATINGS							
Parameter		Symbol	Typical	Maximum	Unit		
Maximum Junction-to-Ambient ^{a, b}	t ≤ 10 s	R _{thJA}	250	300	°C/W		
Maximum Junction-to-Foot (Drain)	Steady State	y State R _{thJF} 225 270		5/ * *			

Notes:

- a. Surface mounted on 1" x 1" FR4 board.
- b. Maximum under steady state conditions is 360 °C/W.

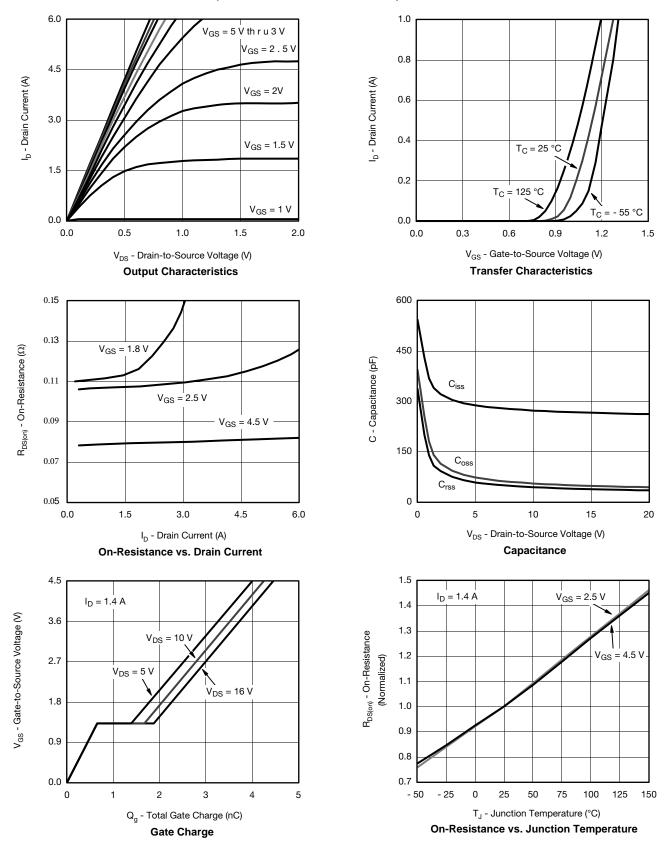
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static		,		l	l	I.
Drain-Source Breakdown Voltage	V _{DS}	V_{DS} $V_{GS} = 0 \text{ V, } I_{D} = -250 \mu\text{A}$				V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	L = 250 ·· A		- 14		mV/°C
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I _D = - 250 μA		2.4		
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	- 0.45		- 1.5	V
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 8 \text{ V}$			± 100	nA
Zara Cata Valtaga Drain Current	I _{DSS}	V _{DS} = - 20 V, V _{GS} = 0 V			- 1	
Zero Gate Voltage Drain Current		$V_{DS} = -20 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 \text{ °C}$			- 10	μA
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \le -5 \text{ V}, V_{GS} = -4.5 \text{ V}$	- 2			Α
		V _{GS} = - 4.5 V, I _D = - 1.4 A		0.080		Ω
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = - 2.5 V, I _D = - 1.2 A		0.100		
	, ,	V _{GS} = - 1.8 V, I _D = - 0.3 A		0.140		
Forward Transconductance ^a	g _{fs}	V _{DS} = - 5 V, I _D = - 1.4 A		5		S
Dynamic ^b						
Input Capacitance	C _{iss}			272		pF
Output Capacitance	C _{oss}	$V_{DS} = -10 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		55		
Reverse Transfer Capacitance	C _{rss}			44		
Total Cata Charge		$V_{DS} = -10 \text{ V}, V_{GS} = -4.5 \text{ V}, I_{D} = -1.4 \text{ A}$		4.3	6.5	
Total Gate Charge				2.7	4.1	
Gate-Source Charge			0.7		nC	
Gate-Drain Charge	Q _{qd}			1.0		
Gate Resistance	R_g	f = 1 MHz	1.4	7	14	Ω
Turn-On Delay Time	t _{d(on)}			12	20	
Rise Time	t _r	$V_{DD} = -10 \text{ V}, R_1 = 9.1 \Omega$		20	30	- - -
Turn-Off DelayTime	t _{d(off)}	$I_{D} \cong -1.1 \text{ A}, V_{GEN} = -4.5 \text{ V}, R_{g} = 1 \Omega$		23	35	
Fall Time	t _f			9	18	
Turn-On Delay Time	t _{d(on)}			5	10	ns
Rise Time	t _r	$V_{DD} = -10 \text{ V}, R_1 = 9.1 \Omega$		10	20	
Turn-Off DelayTime	t _{d(off)}	$I_D \cong$ - 1.1 A, $V_{GEN} = -8 \text{ V}$, $R_g = 1 \Omega$		18	27	
Fall Time	t _f	,,		7	14	1
Drain-Source Body Diode Characterist	ics					
Continuous Source-Drain Diode Current	I _S	T _C = 25 °C			- 2.4	^
ulse Diode Forward Current ^a I _{SM}					- 6	Α
Body Diode Voltage	V _{SD}	I _F = - 0.7 A		- 0.8	- 1.2	V
Body Diode Reverse Recovery Time t _{rr}				18	27	ns
Body Diode Reverse Recovery Charge	Q _{rr}	1 07A 41/4 400A/2 T 0500		7	14	nC
Reverse Recovery Fall Time	t _a	$I_F = -0.7 \text{ A}, \text{ dI/dt} = 100 \text{ A/µs}, T_J = 25 °C$		7		
Reverse Recovery Rise Time	t _b	1		11		ns

Notes:

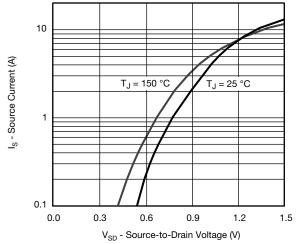
- a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

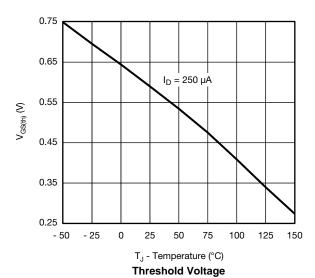


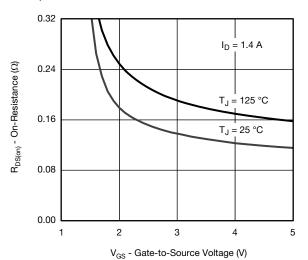




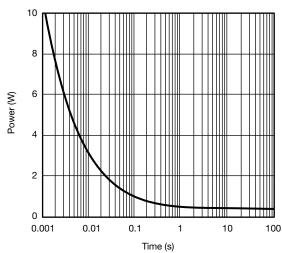


Source-Drain Diode Forward Voltage

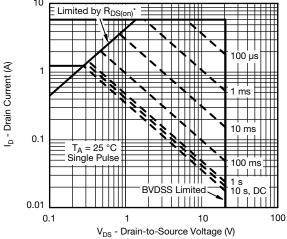




On-Resistance vs. Gate-to-Source Voltage



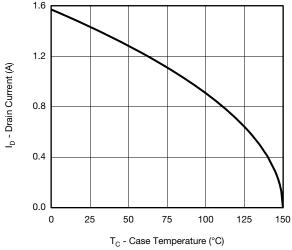
Single Pulse Power, Junction-to-Ambient



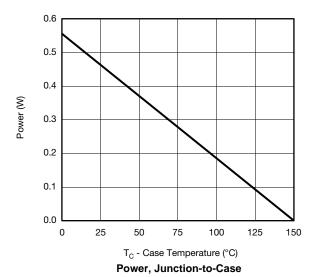
* V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

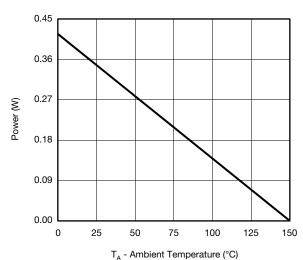
Safe Operating Area, Junction-to-Ambient





Current Derating*

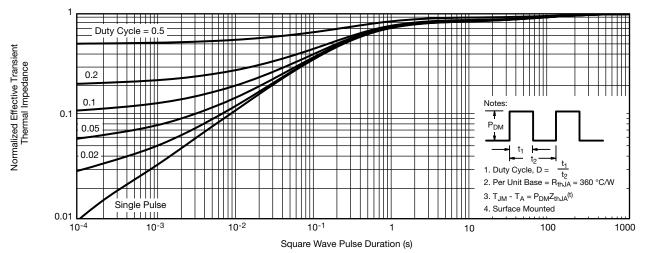




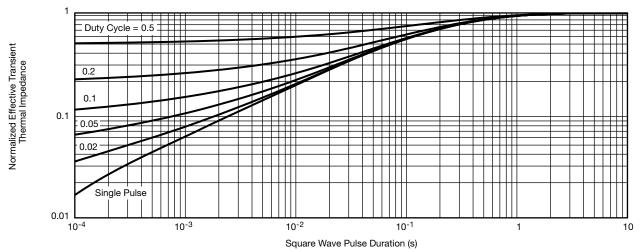
Power, Junction-to-Ambient

^{*} The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit





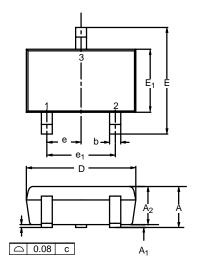
Normalized Thermal Transient Impedance, Junction-to-Ambient

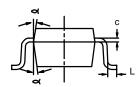


Normalized Thermal Transient Impedance, Junction-to-Foot



SC-70: 3-LEADS

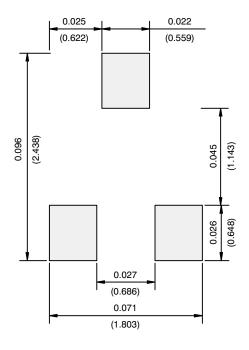




Min	Nom		INCHES		
	NOIII	Max	Min	Nom	Max
0.90	-	1.10	0.035	-	0.043
-	-	0.10	-	-	0.004
0.80	ı	1.00	0.031	1	0.039
0.25	-	0.40	0.010	-	0.016
0.10	1	0.25	0.004	-	0.010
1.80	2.00	2.20	0.071	0.079	0.087
1.80	2.10	2.40	0.071	0.083	0.094
1.15	1.25	1.35	0.045	0.049	0.053
0.65BSC 0.026BSC				;	
1.20	1.30	1.40	0.047	0.051	0.055
0.10	0.20	0.30	0.004	0.008	0.012
7°Nom 7°Nom					
	0.25 0.10 1.80 1.80 1.15	0.25	0.80 - 1.00 0.25 - 0.40 0.10 - 0.25 1.80 2.00 2.20 1.80 2.10 2.40 1.15 1.25 1.35 0.65BSC 1.20 1.30 1.40 0.10 0.20 0.30 7°Nom	0.80 - 1.00 0.031 0.25 - 0.40 0.010 0.10 - 0.25 0.004 1.80 2.00 2.20 0.071 1.80 2.10 2.40 0.071 1.15 1.25 1.35 0.045 0.65BSC 1.20 1.30 1.40 0.047 0.10 0.20 0.30 0.004 7°Nom	0.80 - 1.00 0.031 - 0.25 - 0.40 0.010 - 0.10 - 0.25 0.004 - 1.80 2.00 2.20 0.071 0.079 1.80 2.10 2.40 0.071 0.083 1.15 1.25 1.35 0.045 0.049 0.65BSC 0.026BSC 0.026BSC 1.20 1.30 1.40 0.047 0.051 0.10 0.20 0.30 0.004 0.008 7°Nom 7°Nom 0.004 0.008



RECOMMENDED MINIMUM PADS FOR SC-70: 3-Lead



Recommended Minimum Pads Dimensions in Inches/(mm)



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